



PRODUCT DESCRIPTION

Tflex™ CR350 is a soft, compliant, high thermal conductivity, two-part dispensable gap filler providing a low thermal resistance and high reliability.

This dispensable gap filler minimizes stress on components during assembly while providing the reliability of a traditional thermal pad. Tflex™ CR350 is ideal for application where large gap tolerances are present, meeting vertical shock and vibe requirements, typical of the automotive industry.

The 1:1 mix is easily dispensable through a wide variety of off the shelf dispensing equipment. It is an A+B putty material that cures in place after dispensing and mixing to perfectly fill the gap. The experts at Laird can help design the system that is right for you.

FEATURES AND BENEFITS

- Thermal Conductivity 3.6W/mK
- Dispensable and Compliant
- Easily reworkable
- Ideal for large gaps
- Environmentally friendly solution that meets regulatory requirements

MAIN PROPERTIES

TYPICAL PROPERTIES	VALUE	TEST METHOD
Composition	Two-part ceramic filled dispensable silicone gap filler	
Color	Part A:Pink Part B:White	Visual
Viscosity before combining (cps)	350,000	ASTM D2196
Mix ratio	1:1	
Shelf Life (month)	6	
PROPERTIES AFTER CURING		
Thermal Conductivity (W/mK)	3.6	Hot Disk
Density (g/cc)	3.2	Helium Pycnometer
Hardness (Shore 00 – 3sec)	69	ASTM D2240
Outgassing TML (weight %)	0.58	ASTM E595
Min. bond line thickness (µm)	85	Laird lab
Temperature Range	-40°C to 150°C	Laird Reliability Test
Rth@ 1mm, 50°C, 50psi	0.437 °C-in ² /W	ASTM D5470 (Modified)
Dielectric Breakdown	9KV AC	ASTM D149
Voltage@1mm		
UL Flammability Rating	V-0	Laird LAB
Volume Resistivity	2.6 x 10 ¹⁴ ohm-cm	ISO 14309
Cure condition	1 hour@70°C, 0.5 hour@100°C	Laird LAB

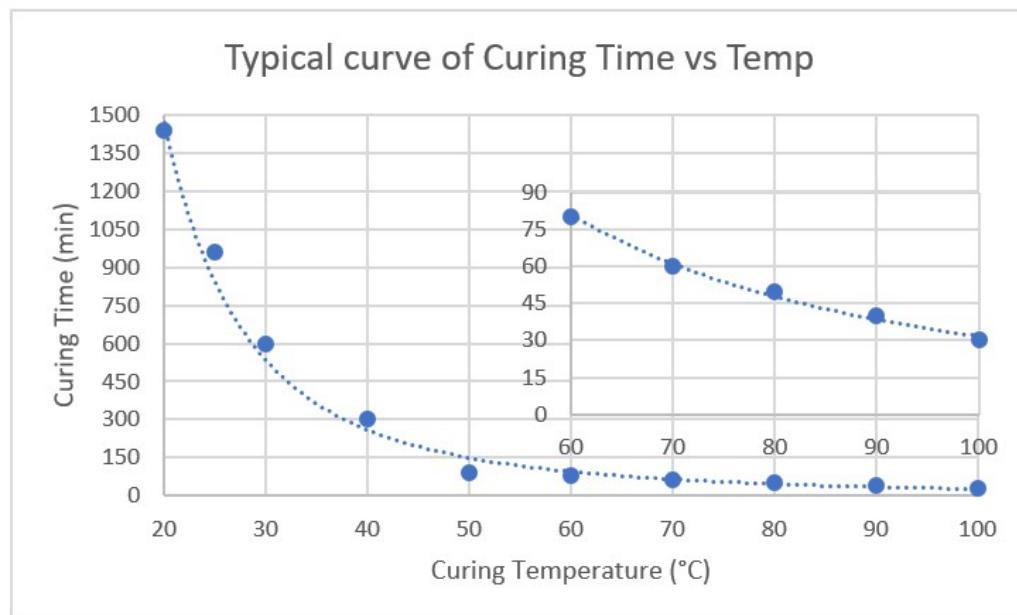
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PACKAGING

TYPE	FILL VOLUME	FILL WEIGHT
50cc duo-cartridge (2x25cc)	47cc	150g
400cc duo-cartridge (2x200cc)	387cc	1240g
1 gallon pail x2	4062cc x2	13kg x2
5 gallons pail x2	6250cc x2	20kg x2

CURING PROFILE



The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.